onsemi

MOSFET – Power, Single, N-Channel

60 V, 15.0 mΩ, 36 A

NTMFS5C677NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit	
			-			
Drain-to-Source Voltage			V _{DSS}	60	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain Current R _{θ.IC}	Steady	$T_{\rm C} = 25^{\circ}{\rm C}$	۱ _D	36	А	
(Notes 1, 3)		T _C = 100°C		25		
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	37	W	
$R_{\theta JC}$ (Note 1)		$T_{C} = 100^{\circ}C$		18		
Continuous Drain		$T_A = 25^{\circ}C$	Ι _D	11	А	
Current R _{θJA} (Notes 1, 2, 3)	Steady	T _A = 100°C		7.8		
Power Dissipation	State	$T_A = 25^{\circ}C$	PD	3.5	W	
$R_{\theta JA}$ (Notes 1 & 2)		$T_A = 100^{\circ}C$		1.8		
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	166	А	
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to + 175	°C	
Source Current (Body Diode)			I _S	31	А	
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 2.87 A)			E _{AS}	65	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

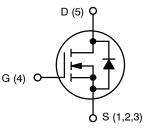
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	4.1	°C/W
Junction-to-Ambient - Steady State (Note 2)	Reia	43	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

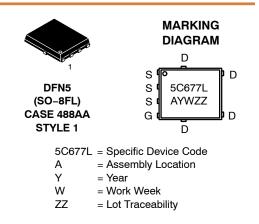
2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	15.0 m Ω @ 10 V	36 A
00 V	21.5 mΩ @ 4.5 V	30 A



N-CHANNEL MOSFET



ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

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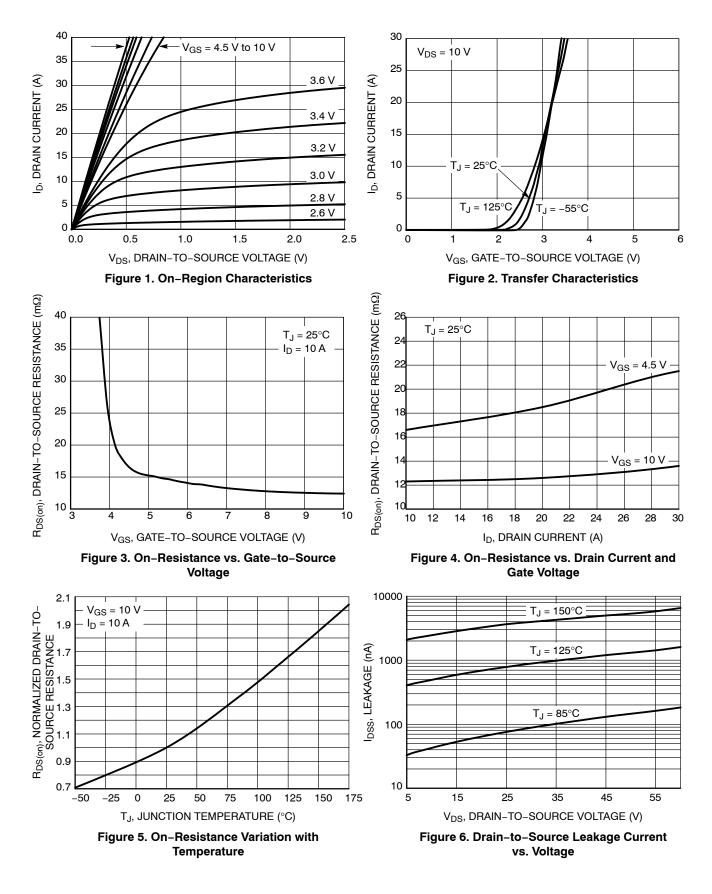
ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				26		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 60 V	$T_J = 25 \ ^{\circ}C$			10	
		v _{DS} = 00 v	$T_J = 125^{\circ}C$			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	_S = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 25 \ \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A		12.5	15.0	0
		V _{GS} = 4.5 V	I _D = 10 A		17.9	21.5	mΩ
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _D = 15 A			27.5		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			620		pF
Output Capacitance	C _{OSS}				340		
Reverse Transfer Capacitance	C _{RSS}				7		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 48 V; I _D = 10 A			4.5		nC
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 10 A			9.7		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 10 A			1.3		
Gate-to-Source Charge	Q _{GS}				2.1		nC
Gate-to-Drain Charge	Q _{GD}				1		
Plateau Voltage	V _{GP}				3.0		V
SWITCHING CHARACTERISTICS (Note 5	.)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 48 V, I _D = 10 A, R _G = 1 Ω			7		
Rise Time	tr				13		ns
Turn-Off Delay Time	t _{d(OFF)}				25		
Fall Time	t _f				6		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	T _J = 25°C 0.85 1.2				
		$I_{\rm S} = 10 \rm{A}$	T _J = 125°C		0.72 V	V	
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIs/dt = 100 A/µs, I _S = 10 A			23.8		
Charge Time	t _a				11.9		ns
Discharge Time	t _b				11.8		
Reverse Recovery Charge	Q _{RR}				11.6		nC

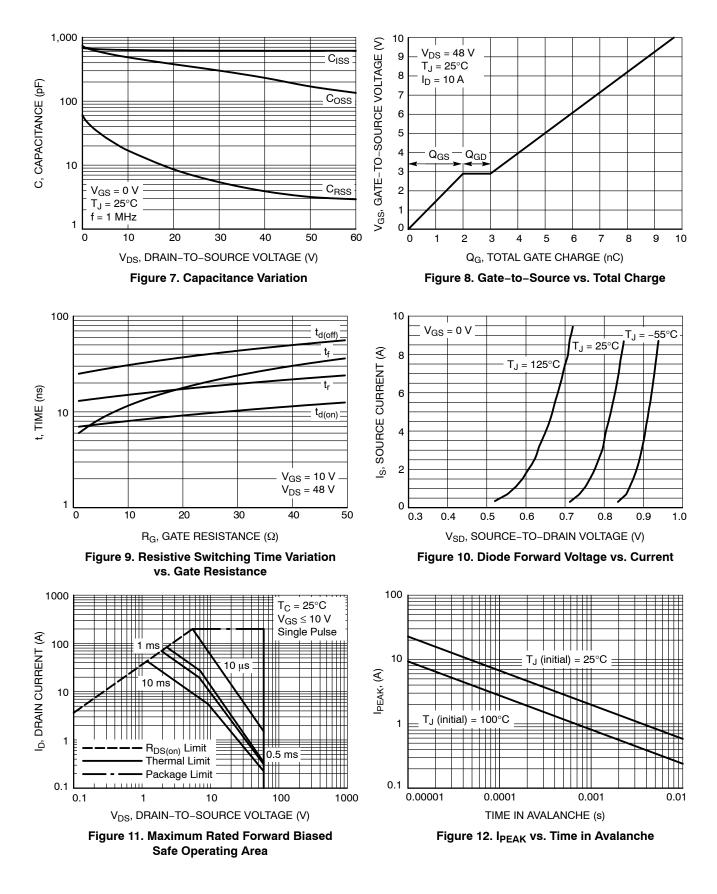
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



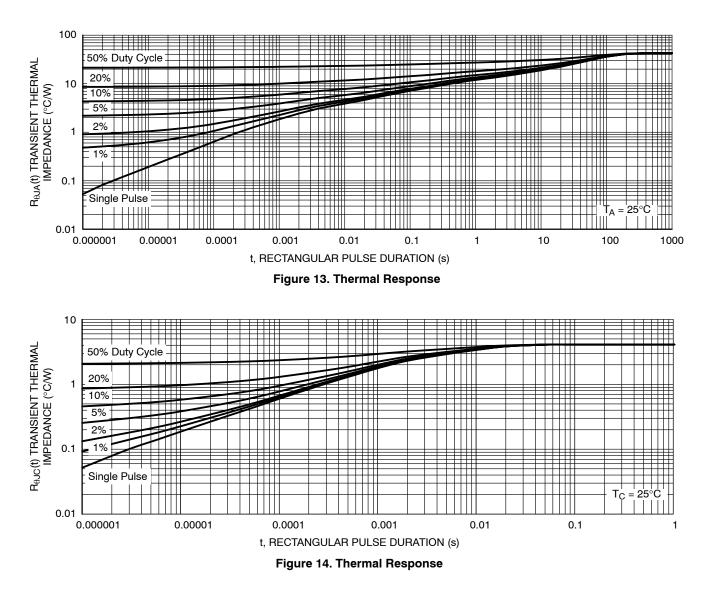
TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS



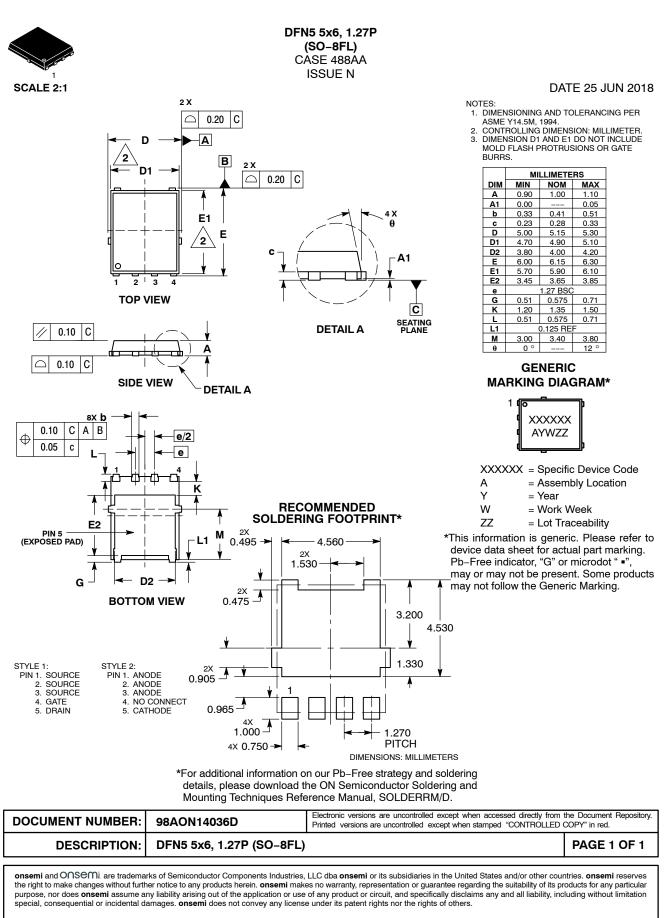
DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFS5C677NLT1G	5C677L	DFN5 (Pb–Free)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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